

TO-46 Package with Lens

DS5473 ISSUE 1 May 2001

#### **Ordering Information**

MF443 13451.11 TO-46 Package MF443 PT 15169.11 Pigtail including

1.4m of 50/215mm multi mode fibre

and SC connector

Note: The rated Responsivity applies to all options.

### **Description**

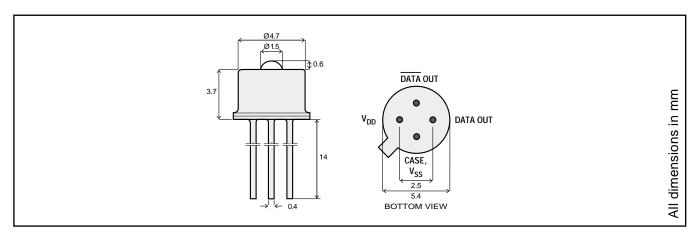
This device consists of a PIN photodiode and a transimpedance amplifier assembled in a TO-46 package. It is designed for FDDI, ATM and SDH/ Sonet up to 155 Mbps. The AGC (Automatic Gain Control) ensures a wide dynamic range. Its double-lens optical system is designed for single-mode fiber as well as for multimode fiber with core diameter up to  $62.5 \mu m$ .

## Optical and Electrical Characteristics - Case Temperature 25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Responsivity, single differential	R		100 200		kV/W	λ=1300nm Note 1
Output Voltage (differential, peak to peak)	V <sub>o</sub>			1.2	V	
Bandwidth (3dB <sub>el</sub> )	f <sub>C</sub>		140		MHz	P <sub>f</sub> =1μW
Noise-Equivalent Power	NEP		15		nW	λ=1300nm
Sensitivity (BER 10 <sup>-9</sup> )	S		-39		dBm	λ=1300 nm
Dynamic Range		36	40		dB	Extinction Ratio = 0
Output Resistance (differential)	R <sub>o</sub>		50		Ω	
Power Supply Current	I <sub>DD</sub>		32	40	mA	

Operating Conditions: See table. Fiber: Single-mode to multimode 62.5/125µm

Note 1: Pf = IMW average power at 100MHz/50% duty cycle



## **Absolute Maximum Ratings**

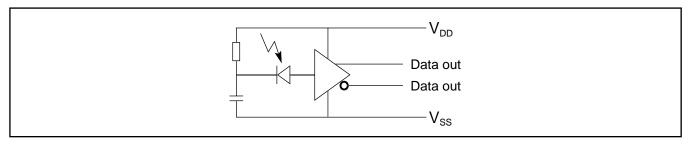
Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	$V_{\rm DD}$ - $V_{\rm SS}$	0	6.0	V
Operating Temperature	$T_{op}$	-40	+85	°C
Storage Temperature	$T_{ m stg}$	-55	+125	°C

# **Recommended Operating Conditions**

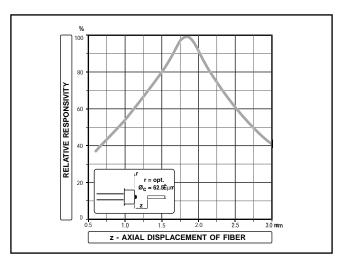
Parameter	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage	$V_{\rm DD}$ - $V_{\rm SS}$	4.5	5.0	5.2	V
Output Differential Load	$R_{L}$	1	3		kΩ

# **Typical Responsivity**

	Core Diameter/Cladding Diameter Numberical Aperture				
	10/125μm	50/125μm	62.5/125μm		
	0.11	0.20	0.275		
Single	100kV/W	100kV/W	100kV/W		
Differential	200kV/W	200kV/W	200kV/W		



**Functional Schematic** 



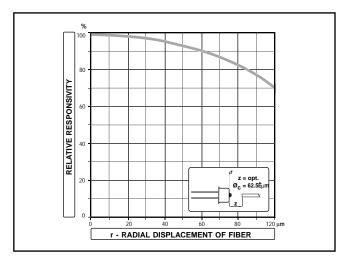


Figure 1 Figure 2

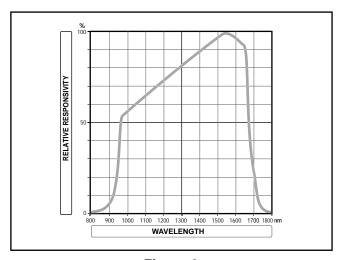


Figure 3



# For more information about all Zarlink products visit our Web Site at

www.zarlink.com

Information relating to products and services furnished herein by Zarlink Semiconductor Inc. trading as Zarlink Semiconductor or its subsidiaries (collectively "Zarlink") is believed to be reliable. However, Zarlink assumes no liability for errors that may appear in this publication, or for liability otherwise arising from the application or use of any such information, product or service or for any infringement of patents or other intellectual property rights owned by third parties which may result from such application or use. Neither the supply of such information or purchase of product or service conveys any license, either express or implied, under patents or other intellectual property rights owned by Zarlink or licensed from third parties by Zarlink, whatsoever. Purchasers of products are also hereby notified that the use of product in certain ways or in combination with Zarlink, or non-Zarlink furnished goods or services may infringe patents or other intellectual property rights owned by Zarlink.

This publication is issued to provide information only and (unless agreed by Zarlink in writing) may not be used, applied or reproduced for any purpose nor form part of any order or contract nor to be regarded as a representation relating to the products or services concerned. The products, their specifications, services and other information appearing in this publication are subject to change by Zarlink without notice. No warranty or guarantee express or implied is made regarding the capability, performance or suitability of any product or service. Information concerning possible methods of use is provided as a guide only and does not constitute any guarantee that such methods of use will be satisfactory in a specific piece of equipment. It is the user's responsibility to fully determine the performance and suitability of any equipment using such information and to ensure that any publication or data used is up to date and has not been superseded. Manufacturing does not necessarily include testing of all functions or parameters. These products are not suitable for use in any medical products whose failure to perform may result in significant injury or death to the user. All products and materials are sold and services provided subject to Zarlink's conditions of sale which are available on request.

Purchase of Zarlink's  $I^2C$  components conveys a licence under the Philips  $I^2C$  Patent rights to use these components in an  $I^2C$  System, provided that the system conforms to the  $I^2C$  Standard Specification as defined by Philips.

Zarlink and the Zarlink Semiconductor logo are trademarks of Zarlink Semiconductor Inc.

Copyright 2002, Zarlink Semiconductor Inc. All Rights Reserved.

TECHNICAL DOCUMENTATION - NOT FOR RESALE